onsemi

6-Pin DIP Phototransistor Optocouplers

H11AV1M, H11AV1AM

Description

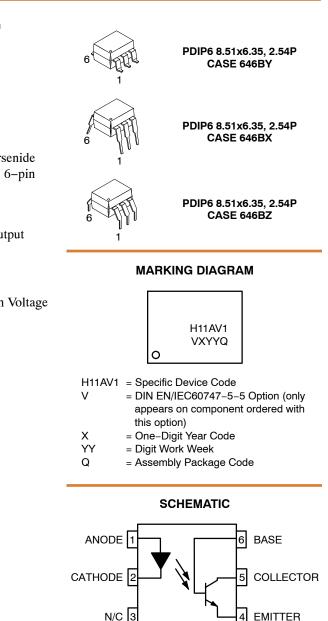
The general purpose optocouplers consist of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a 6-pin dual in-line white package.

Features

- H11AV1M and H11AV1AM Feature 0.3" and 0.4" Input–Output Lead Spacing Respectively
- Safety and Regulatory Approvals:
 - UL1577, 4,170 VAC_{RMS} for 1 Minute
 - DIN-EN/IEC60747-5-5, 850 V Peak Working Insulation Voltage

Applications

- Power Supply Regulators
- Digital Logic Inputs
- Microprocessor Inputs



ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

SAFETY AND INSULATION RATINGS (As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.)

Parameter		Characteristics
Installation Classifications per DIN VDE 0110/1.89 Table 1,	<150 V _{RMS}	I–IV
For Rated Mains Voltage	<300 V _{RMS}	I–IV
Climatic Classification	55/100/21	
Pollution Degree (DIN VDE 0110/1.89)	2	
Comparative Tracking Index		175

Symbol	Parameter	Value	Unit
V_{PR}	Input-to-Output Test Voltage, Method A, $V_{IORM} x 1.6 = V_{PR}$, Type and Sample Test with $t_m = 10$ s, Partial Discharge < 5 pC	1360	V _{peak}
	Input–to–Output Test Voltage, Method B, $V_{IORM} x 1.875 = V_{PR}$, 100% Production Test with $t_m = 1 $ s, Partial Discharge < 5 pC	1594	V _{peak}
VIORM	Maximum Working Insulation Voltage	850	V _{peak}
V _{IOTM}	Highest Allowable Over-Voltage	6000	V _{peak}
	External Creepage	≥7	mm
	External Clearance	≥7	mm
	External Clearance (for Option TV, 0.4" Lead Spacing)	≥10	mm
DTI	Distance Through Insulation (Insulation Thickness)	≥0.5	mm
Τs	Case Temperature (Note 1)	175	°C
I _{S,INPUT}	Input Current (Note 1)	350	mA
P _{S,OUTPUT}	Output Power (Note 1)	800	mW
R _{IO}	Insulation Resistance at T _S , V _{IO} = 500 V (Note 1)	>10 ⁹	Ω

1. Safety limit values - maximum values allowed in the event of a failure.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Мах	Unit
OTAL DEV	ICE		
T _{STG}	Storage Temperature	-40 to +125	°C
T _{OPR}	Operating Temperature	-40 to +100	°C
TJ	Junction Temperature	-40 to +125	°C
T _{SOL}	Lead Solder Temperature	260 for 10 seconds	°C
PD	Total Device Power Dissipation @ T _A = 25°C	270	mW
	Derate Above 25°C	2.94	mW/°C
MITTER			
١ _F	DC / Average Forward Input Current	60	mA
V _R	Reverse Input Voltage	6	V
PD	LED Power Dissipation @ $T_A = 25^{\circ}C$	120	mW
	Derate Above 25°C	1.41	mW/°C
ETECTOR			
V _{CEO}	Collector-to-Emitter Voltage	70	V
V _{CBO}	Collector-to-Base Voltage	70	V
V _{ECO}	Emitter-to-Collector Voltage	7	V
PD	Detector Power Dissipation @ $T_A = 25^{\circ}C$	150	mW
	Derate Above 25°C	1.76	mW/°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS - INDIVIDUAL COMPONENT CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
EMITTER					-	-
V _F	Input Forward Voltage (I _F = 10 mA)	T _A = 25°C	0.80	1.18	1.50	V
		$T_A = -55^{\circ}C$	0.90	1.28	1.70	
		T _A = 100°C	0.70	1.05	1.40	
I _R	Reverse Leakage Current	V _R = 6.0 V	-	-	10	μΑ
DETECTOR						
BV _{CEO}	Collector-to-Emitter Breakdown Voltage	I _C = 1.0 mA, I _F = 0	70	100	_	V
BV _{CBO}	Collector-to-Base Breakdown Voltage	I _C = 100 μA, I _F = 0	70	1200	-	V
BV _{ECO}	Emitter-to-Collector Breakdown Voltage	I _E = 100 μA, I _F = 0	7	10	-	V
I _{CEO}	Collector-to-Emitter Dark Current	V _{CE} = 10 V, I _F = 0	-	1	50	nA
I _{CBO}	Collector-to-Base Dark Current	V _{CB} = 10 V	-	0.5	-	nA
C _{CE}	Capacitance	V _{CE} = 0 V, f = 1 MHz	-	8	_	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS – TRANSFER CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
DC CHARACTERISTIC						
CTR	Current Transfer Ratio, Collector-to-Emitter	I _F = 10 mA, V _{CE} = 10 V	100	-	300	%
V _{CE (SAT)}	Saturation Voltage, Collector-to-Emitter	I _C = 2 mA, I _F = 20 mA	-	-	0.4	V
	TEDISTIC					

T _{ON}	Non-Saturated Turn-on Time	I_C = 2 mA, V_{CC} = 10 V, R_L = 100 Ω (Figure 11)	-	-	15	μs
T _{OFF}	Non Saturated Turn-off Time	I_C = 2 mA, V_{CC} = 10 V, R_L = 100 Ω (Figure 11)	-	-	15	μs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS - ISOLATION CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
V _{ISO}	Input-Output Isolation Voltage	t = 1 Minute	4170	-	-	VAC _{RMS}
C _{ISO}	Isolation Capacitance	V _{I–O} = 0 V, f = 1 MHz	-	0.2	-	pF
R _{ISO}	Isolation Resistance	$V_{I-O}=\pm500~VDC,~T_A=25^\circ C$	1011	-	-	Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CURVES

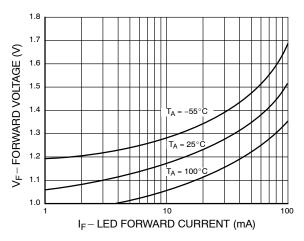


Figure 1. LED Forward Voltage vs. Forward Current

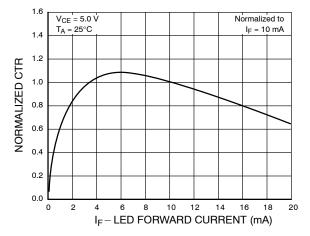


Figure 2. Normalized CTR vs. Forward Current

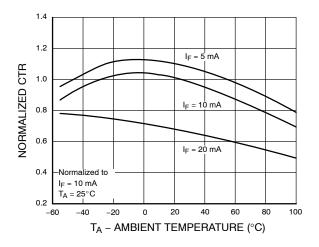


Figure 3. Normalized CTR vs. Ambient Temperature

1.0 0.9

0.8

0.7 0.6

0.5

0.4 0.3

0.2

0.1

0.0

10

(CTR_{RBE} / CTR_{RBE}(OPEN))

NORMALIZED CTR

I_F = 20 m/

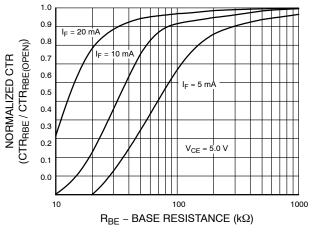
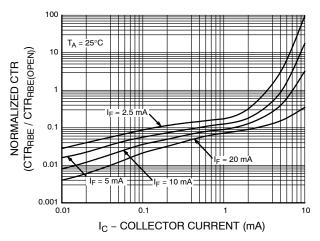
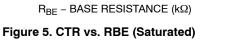


Figure 4. CTR vs. RBE (Unsaturated)





100

 $I_F = 5 mA$

I_F = 10 mA

Figure 6. Collector–Emitter Saturation Voltage vs. Collector Current

1000

TYPICAL PERFORMANCE CURVES (continued)

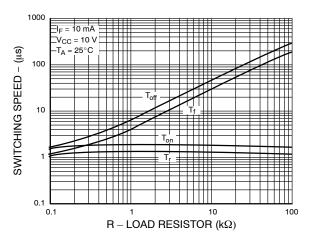


Figure 7. Switching Speed vs. Load Resistor

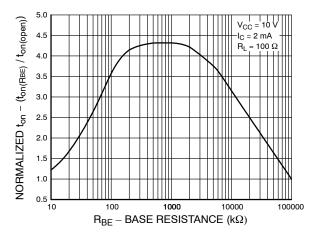


Figure 8. Normalized ton vs. RBE

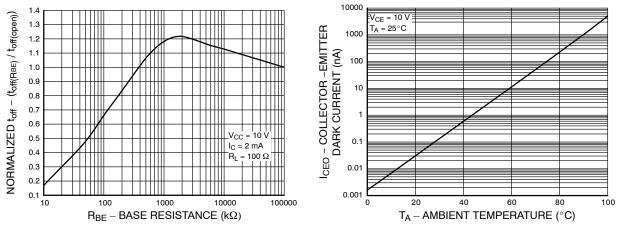


Figure 9. Normalized toff vs. RBE

Figure 10. Dark Current vs. Ambient Temperature

SWITCHING TIME TEST CIRCUIT AND WAVEFORM

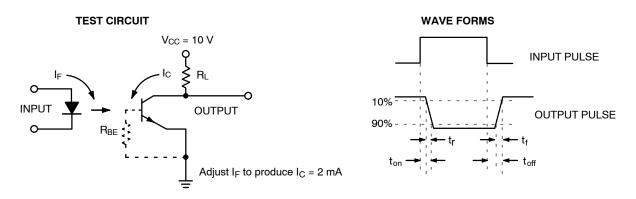
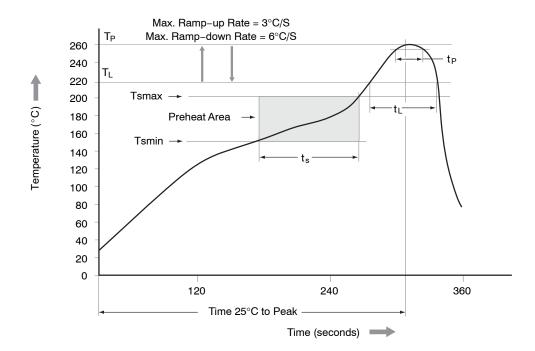


Figure 11. Switching Time Test Circuit and Waveform

REFLOW PROFILE



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t _S) from (Tsmin to Tsmax)	60–120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60–150 seconds
Peak Body Package Temperature	260°C +0°C / –5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

Figure 12. Reflow Profile

ORDERING INFORMATION

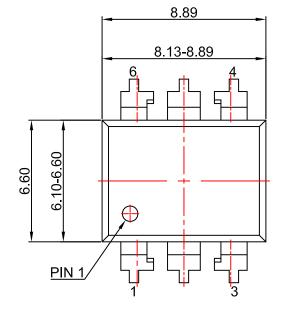
Part Number	Package	Shipping [†]
H11AV1M	DIP 6-Pin 50 Units / Tube	
H11AV1SM	SMT 6-Pin (Lead Bend)	50 Units / Tube
H11AV1SR2M	SMT 6-Pin (Lead Bend)	1000 / Tape & Reel
H11AV1VM	DIP 6-Pin, DIN EN/IEC60747-5-5 Option	50 Units / Tube
H11AV1SVM	SMT 6-Pin (Lead Bend), DIN 50 Units / Tube EN/IEC60747-5-5 Option	
H11AV1SR2VM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	1000 / Tape & Reel
H11AV1AM	DIP 6-Pin, 0.4" Lead Spacing	50 Units / Tube
H11AV1AVM	DIP 6-Pin, 0.4" Lead Spacing, DIN EN/IEC60747-5-5 Option	50 Units / Tube

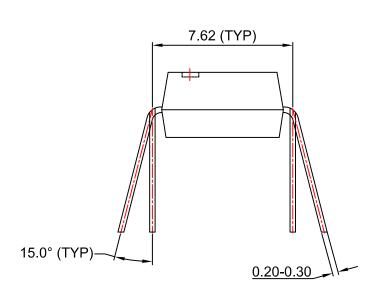
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

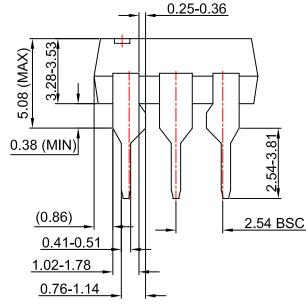


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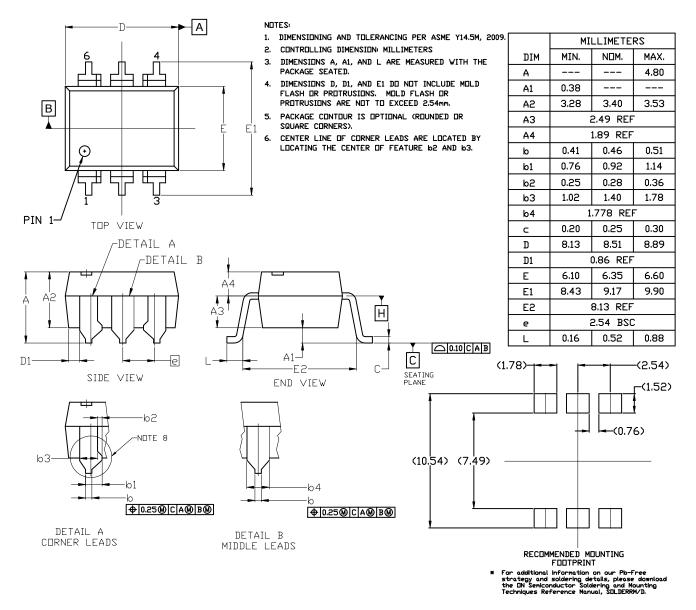
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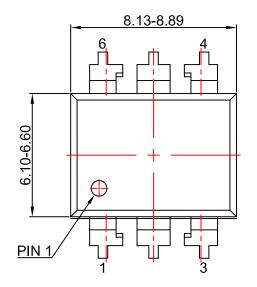


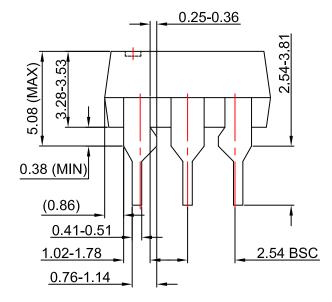
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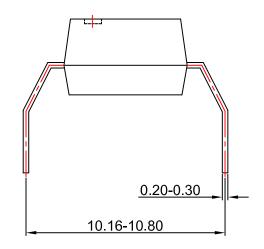


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